# Cyntec

# **Shunt Sensor**

### VSMA8420AY-M050JE

#### **Features / Applications**

- High power rating is up to 36W
- Low inductance (< 5 nH)
- Low thermal EMF (< 3 μV/°C)</p>
- Welding construction; excellent long-term stability
- RoHS compliant and AEC-Q200 qualified
- Automotive applications and current sensing for BMS
- Sn plating assists with PCB mounting and corrosion protection

#### **Electrical Specifications**

Characteristics	Feature
Power Rating*	36 W
Resistance Value	50 μΩ
Temperature Coefficient of Resistance	± 100 ppm/°C
Operation Temperature Range	-65°C ~ +170°C
Resistance Tolerance	± 5% (J)
Maximum Working Voltage (V)	( P*R) <sup>1/2</sup>

\*Note :

For sensors operated at terminal temperature in excess of 140°C, the maximum load shall be derated in accordance with the following curve.

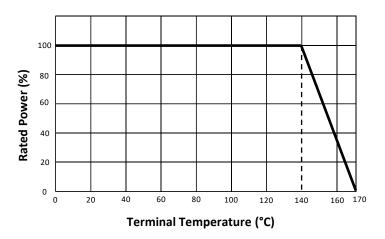


Figure 1. Power derating curve at terminal temperature

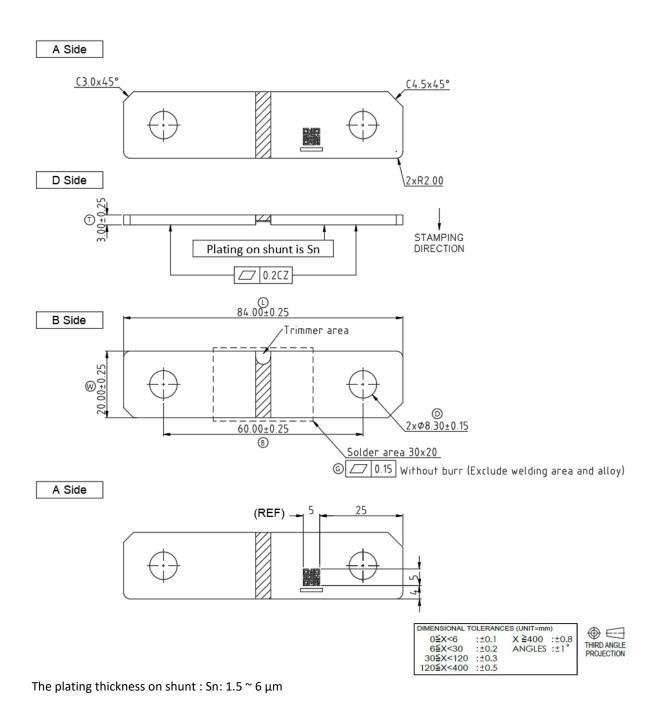
DOCUMENT : VSMA8420AYM050JEW VERSION : A1 PAGE : 1





#### **Outline Drawing**

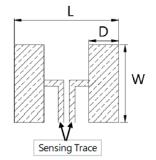
Dimension



DOCUMENT:VSMA8420AYM050JEWVERSION:A1PAGE:2



#### **Recommended Dimensions of the Land Pad**



Resistance	Dimensions (mm)			
Range	L	D	W	
50 μΩ	11.95	4	21	

#### **Type Designation**

V S M A	8420	А	Y	-	M 0 5 0	J	Е
(1)	(2)	(3)	(4)	-	(5)	(6)	(7)

Note:

- (1) Series number
- (2) Size
- (3) Terminal type: A = internal code
- (4) Power Rating: Y = 36W
- (5) Resistance value: M050 = 50  $\mu\Omega$
- (6) Tolerance:  $J = \pm 5\%$
- (7) Internal code



#### Characteristics

#### Electrical

ltem	Specification and Requirement	Test Method
Temperature		JIS-C-5201
Coefficient (TCR)	As follow specification	+25°C/+125°C
Short Time Overload	$ riangle R:\pm$ 0.5 % Without damage by flashover, spark, arcing, burning or breakdown	JIS-C-5201-1 4.13 5 x rated power for 5 seconds
ESD	$\triangle R: \pm 1\%$	AEC-Q200-002 Human body, 8KV.

#### Mechanical

Item	Specification and Requirement	Test Method	
Solderability	The surface of terminal immersed shall be minimum of 95 % covered with a new coating of solder	J-STD-002 245 $\pm$ 5°C for 20 $\pm$ 0.5 seconds	
Resistance to Solder Heat	$\triangle R:\pm 0.5$ %	MIL-STD-202 Method 210 260 $\pm$ 5°C for 10 $\pm$ 1 seconds	
Vibration	$ riangle R:\pm$ 0.5 % Without distinct damage in appearance	MIL-STD-202 Method 204 5G's for 20 minutes, 12 cycles each of 3 orientations. Test from 10-2000Hz.	
Mechanical Shock	$\triangle R: \pm 0.5\%$ Without distinct damage in appearance	MIL-STD-202 Method 213 100G's peak value, 6ms, Half-sine waveform, 12.3 ft/sec.	



#### Endurance

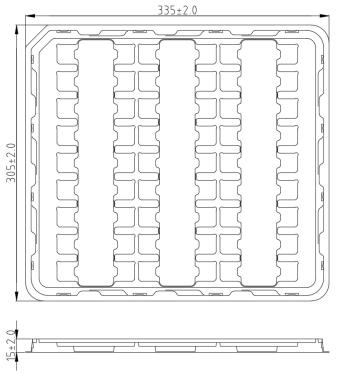
ltem	Specification and Requirement	Test Method		
		JESD22 Method JA-104		
Tomporaturo Cycling	$\triangle R:\pm0.5$ %	1000 cycles, (-55°C ~ 155°C)		
Temperature Cycling		30 minutes maximum dwell time at		
		each temperature		
		MIL-STD-202 Method 103		
Biased Humidity	$\triangle R:\pm 0.5$ %	1000 hours, 85°C / 85% R.H,		
		applied for 10 % rated power		
		MIL-STD-202 Method 108		
Operational Life	$\triangle$ R: ± 1.0 %	100 % rate power for 1,000 hours		
		at terminal temperature 140°C		
High Temperature Store	$\triangle R: \pm 1.0 \%$	MIL-STD-202 Method 108 170°C for 1,000 hours		

Note : Measurement at 24  $\pm$  4 hours after test conclusion for all reliability tests-parts.



### Packaging

#### Tray packaging dimensions :



#### Label Marking :

The following items shall be marked on tray

- (1) Description
- (2) Quantity
- (3) Part No.
- (4) Tapping No.

#### Quantity:

135 Pcs / Carton



#### **Care Note**

#### Care note for storage

- (1) Shunt sensor shall be stored in a environment where temperature and humidity must be controlled (temperature 5 to 35°C, humidity < 60% RH). However, the humidity should be maintained as low as possible.
- (2) Shunt sensor shall not be stored under direct sunlight.
- (3) Shunt sensor shall be stored in condition without moisture, dust, any material defect solderability, or hazardous gas (i.e. hydrogen chloride, sulfurous acid gas, and hydrogen sulfide)
- (4) The sensor can be stored for two years under the condition mentioned above.

#### Care note for operating and handling

- (1) Protect the edge and coating of the sensors from mechanical stress.
- (2) Avoid bending of printing circuit board (PCB) when cutting and fixing it on support body to reduce mechanical stress on sensors.
- (3) Sensor should be used within the condition of specification.

Note: When a voltage higher than specified value is loaded to the sensor, this may damage the sensor material due to temperature rise.

- (4) The loaded voltage should consult terminal temperature of the sensor according to the derating curve.
- (5) When applying a high current exceeding suggested specification (pulse current, shock current) to the sensor, it is necessary to re-evaluate the operating condition before using it in the system.